

# MOSFET – N-Channel, UniFET™ FRFET® 500 V, 100 A, 55 mΩ

## FDL100N50F

### Description

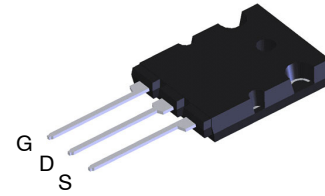
UniFET MOSFET is onsemi's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. The body diode's reverse recovery performance of UniFET FRFET MOSFET has been enhanced by lifetime control. Its trr is less than 100 nsec and the reverse dv/dt immunity is 15 V/ns while normal planar MOSFET's have over 200 nsec and 4.5 V/nsec respectively. Therefore, it can remove additional component and improve system reliability in certain applications in which the performance of MOSFET's body diode is significant. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.

### Features

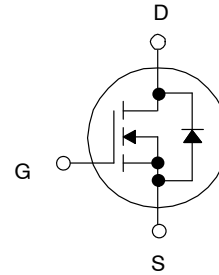
- $R_{DS(on)} = 43 \text{ m}\Omega$  (Typ.) @  $V_{GS} = 10 \text{ V}$ ,  $I_D = 50 \text{ A}$
- Low Gate Charge (Typ. 238 nC)
- Low  $C_{rss}$  (Typ. 64 pF)
- 100% Avalanche Tested
- Improved dv/dt Capability
- RoHS Compliant

### Applications

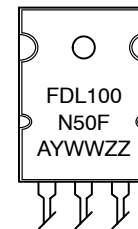
- Uninterruptible Power Supply
- AC-DC Power Supply



TO-264-3LD  
 CASE 340CA



### MARKING DIAGRAM



- A = Assembly Location
- YWW = Date Code
- ZZ = Assembly Lot

### ORDERING INFORMATION

See detailed ordering and shipping information on page 3 of this data sheet.

# FDL100N50F

## MOSFET MAXIMUM RATINGS ( $T_J = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	FDL100N50F	Unit
$V_{DSS}$	Drain to Source Voltage	500	V
$V_{GSS}$	Gate to Source Voltage	$\pm 30$	V
$I_D$	Drain Current	- Continuous ( $T_C = 25^\circ\text{C}$ )	100
		- Continuous ( $T_C = 100^\circ\text{C}$ )	60
$I_{DM}$	Drain Current	- Pulsed (Note 1)	400
$E_{AS}$	Single Pulsed Avalanche Energy	(Note 2)	5000
$I_{AR}$	Avalanche Current	(Note 1)	100
$E_{AR}$	Repetitive Avalanche Energy	(Note 1)	73.5
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	20
$P_D$	Power Dissipation	( $T_C = 25^\circ\text{C}$ )	2500
		- Derate Above $25^\circ\text{C}$	20
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150	$^\circ\text{C}$
$T_L$	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds	300	$^\circ\text{C}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse-width limited by maximum junction temperature.
2.  $L = 1\text{ mH}$ ,  $I_{AS} = 100\text{ A}$ ,  $V_{DD} = 50\text{ V}$ ,  $R_G = 25\ \Omega$ , starting  $T_J = 25^\circ\text{C}$ .
3.  $I_{SD} \leq 100\text{ A}$ ,  $di/dt \leq 200\text{ A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , starting  $T_J = 25^\circ\text{C}$ .

## THERMAL CHARACTERISTICS

Symbol	Parameter	FDL100N50F	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.05	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	30	

## ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
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### OFF CHARACTERISTICS

$BV_{DSS}$	Drain to Source Breakdown Voltage	$I_D = 250\ \mu\text{A}$ , $V_{GS} = 0\text{ V}$ , $T_C = 25^\circ\text{C}$	500	-	-	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250\ \mu\text{A}$ , Referenced to $25^\circ\text{C}$	-	0.5	-	$\text{V}/^\circ\text{C}$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 500\text{ V}$ , $V_{GS} = 0\text{ V}$	-	-	10	$\mu\text{A}$
		$V_{DS} = 400\text{ V}$ , $T_C = 125^\circ\text{C}$	-	-	100	
$I_{GSS}$	Gate to Body Leakage Current	$V_{GS} = \pm 30\text{ V}$ , $V_{DS} = 0\text{ V}$	-	-	$\pm 100$	nA

### ON CHARACTERISTICS

$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250\ \mu\text{A}$	3.0	-	5.0	V
$R_{DS(on)}$	Static Drain to Source On Resistance	$V_{GS} = 10\text{ V}$ , $I_D = 50\text{ A}$	-	0.043	0.055	$\Omega$
gFS	Forward Transconductance	$V_{DS} = 20\text{ V}$ , $I_D = 50\text{ A}$	-	95	-	S

### DYNAMIC CHARACTERISTICS

$C_{iss}$	Input Capacitance	$V_{DS} = 25\text{ V}$ , $V_{GS} = 0\text{ V}$ , $f = 1\text{ MHz}$	-	12000	-	pF
$C_{oss}$	Output Capacitance		-	1700	-	pF
$C_{riss}$	Reverse Transfer Capacitance		-	64	-	pF
$Q_{g(tot)}$	Total Gate Charge at 10V	$V_{DD} = 400\text{ V}$ , $I_D = 50\text{ A}$ , $V_{GS} = 10\text{ V}$ (Note 4)	-	238	-	nC
$Q_{gs}$	Gate to Source Gate Charge		-	74	-	nC
$Q_{gd}$	Gate to Drain "Miller" Charge		-	95	-	nC

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## ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ unless otherwise noted) (continued)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
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### SWITCHING CHARACTERISTICS

$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 250\text{ V}$ , $I_D = 50\text{ A}$ , $V_{GS} = 10\text{ V}$ , $R_G = 4.7\ \Omega$ (Note 4)	–	63	–	ns
$t_r$	Turn-On Rise Time		–	186	–	ns
$t_{d(off)}$	Turn-Off Delay Time		–	202	–	ns
$t_f$	Turn-Off Fall Time		–	105	–	ns

### DRAIN-SOURCE DIODE CHARACTERISTICS

$I_S$	Maximum Continuous Drain to Source Diode Forward Current		–	–	100	A
$I_{SM}$	Maximum Pulsed Drain to Source Diode Forward Current		–	–	400	A
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0\text{ V}$ , $I_{SD} = 100\text{ A}$	–	–	1.5	V
$t_{rr}$	Reverse Recovery Time	$V_{GS} = 0\text{ V}$ , $I_{SD} = 100\text{ A}$ $dI_F/dt = 100\text{ A}/\mu\text{s}$	–	250	–	ns
$Q_{rr}$	Reverse Recovery Charge		–	1.5	–	$\mu\text{C}$

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.

### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Reel Size	Tape Width	Shipping <sup>†</sup>
FDL100N50F	FDL100N50F	TO – 264	N/A	N/A	25 Units / Tube

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, [BRD8011/D](#).

TYPICAL CHARACTERISTICS

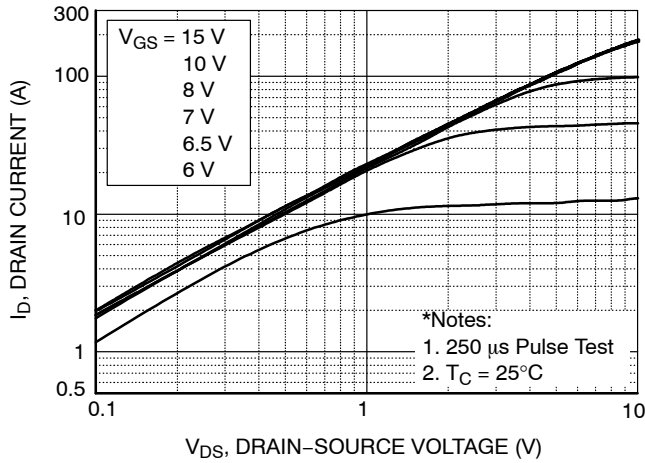


Figure 1. On-Region Characteristics

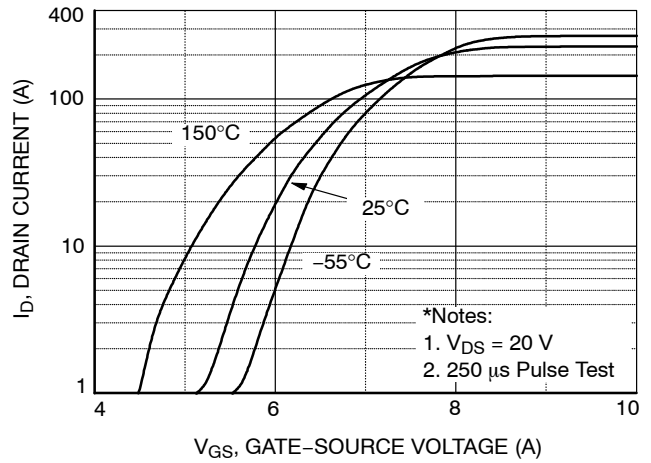


Figure 2. Transfer Characteristics

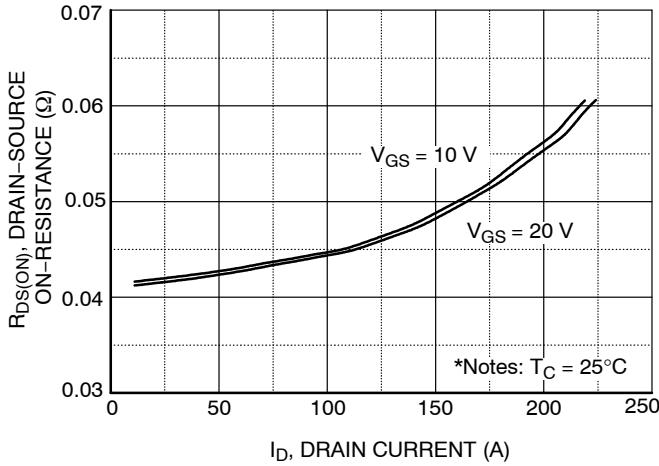


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

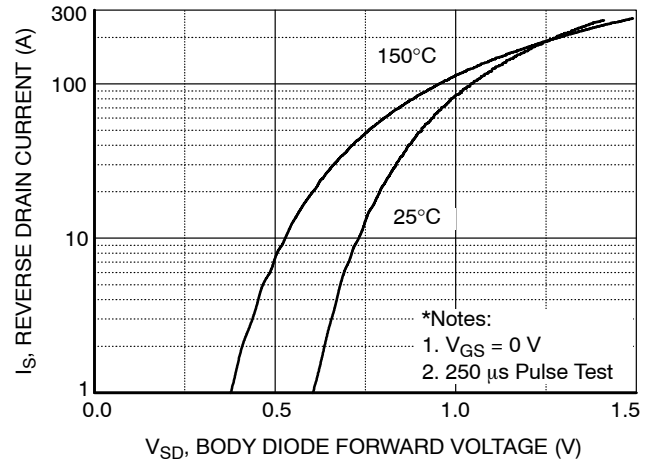


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

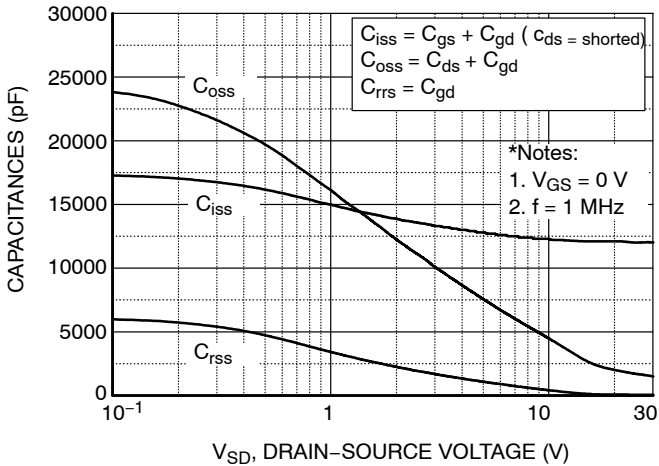


Figure 5. Capacitance Characteristics

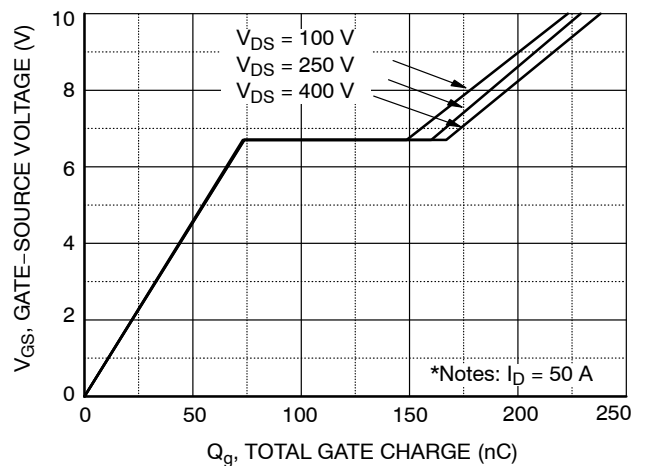
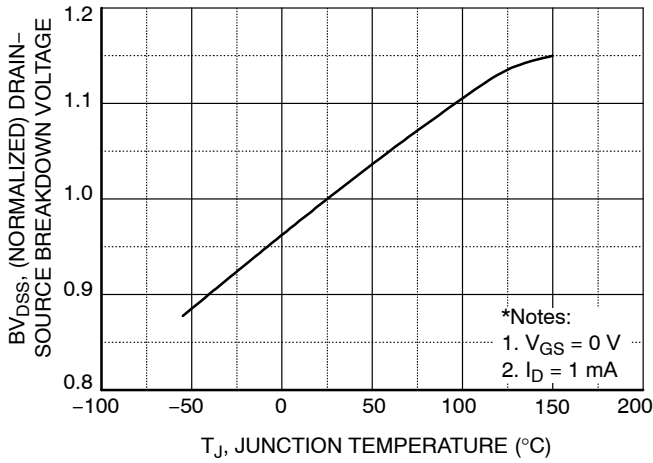


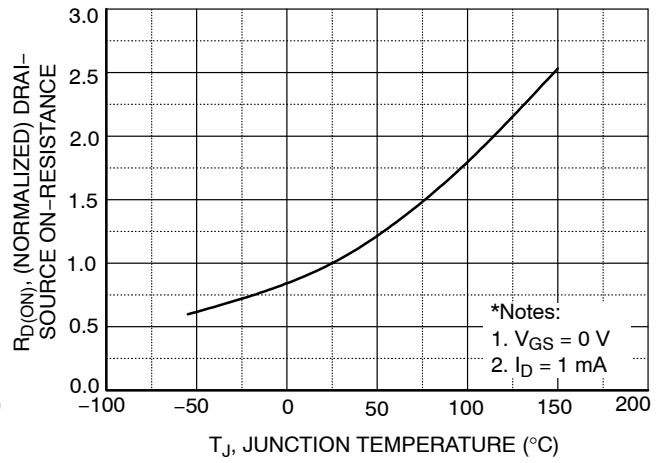
Figure 6. Gate Charge Characteristics

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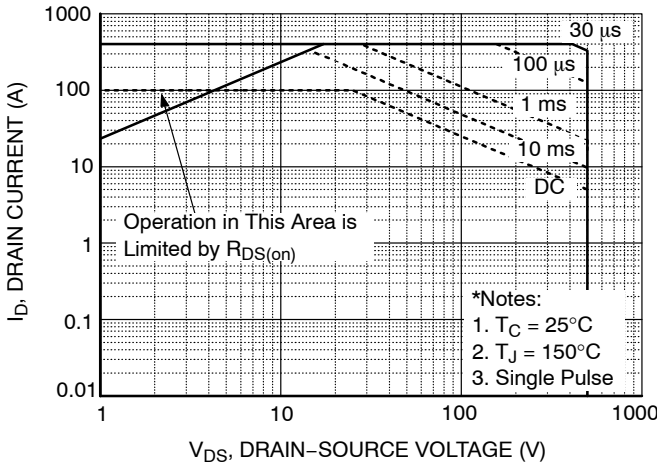
## TYPICAL CHARACTERISTICS (continued)



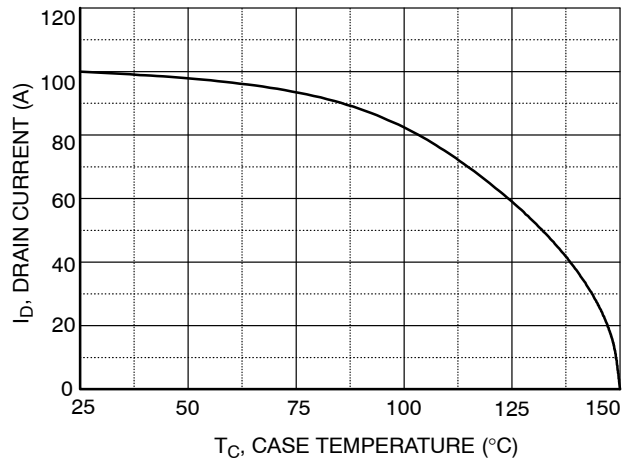
**Figure 7. Breakdown Voltage Variation vs. Temperature**



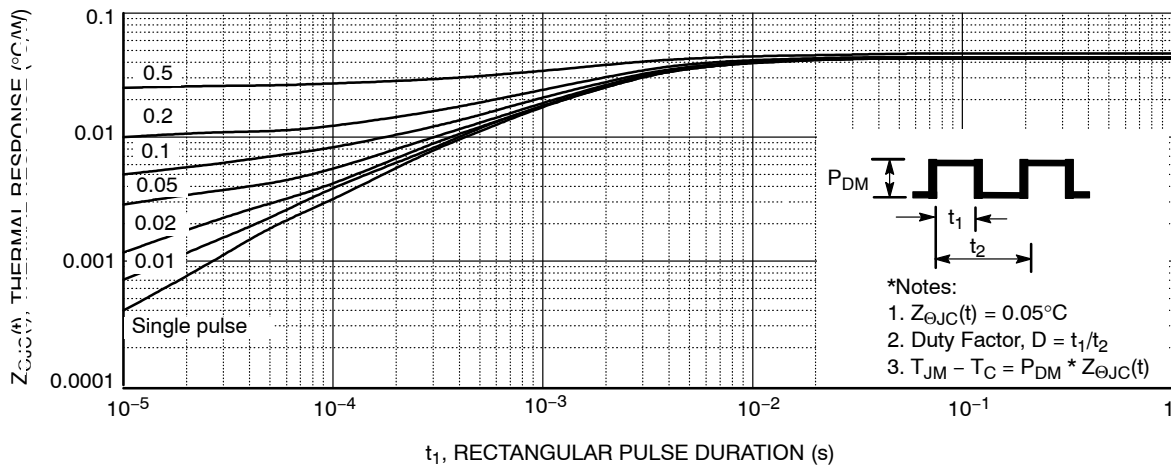
**Figure 8. On-Resistance Variation vs. Temperature**



**Figure 9. Maximum Safe Operating Area**



**Figure 10. Maximum Drain Current vs. Case Temperature**



**Figure 11. Transient Thermal Response Curve**

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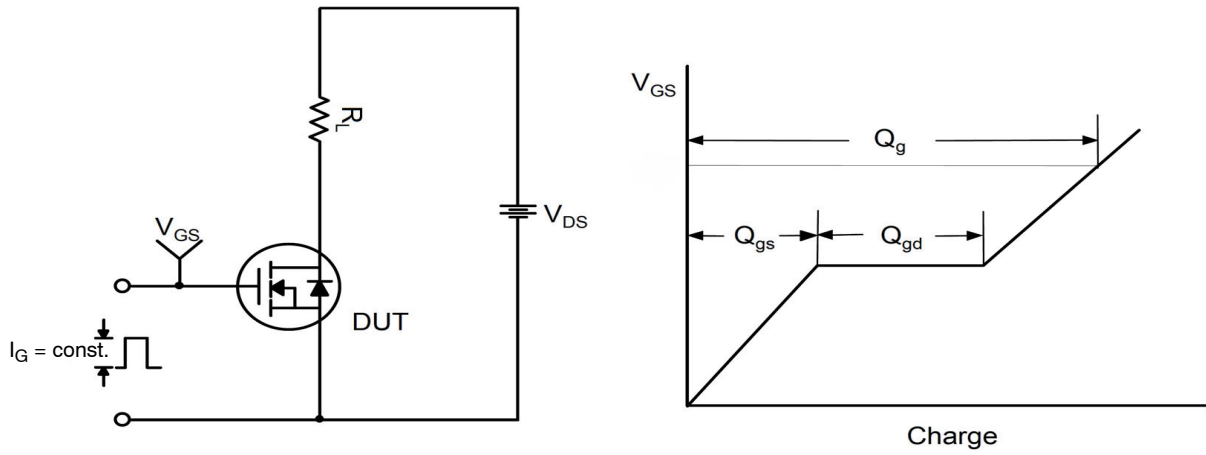


Figure 12. Gate Charge Test Circuit & Waveforms

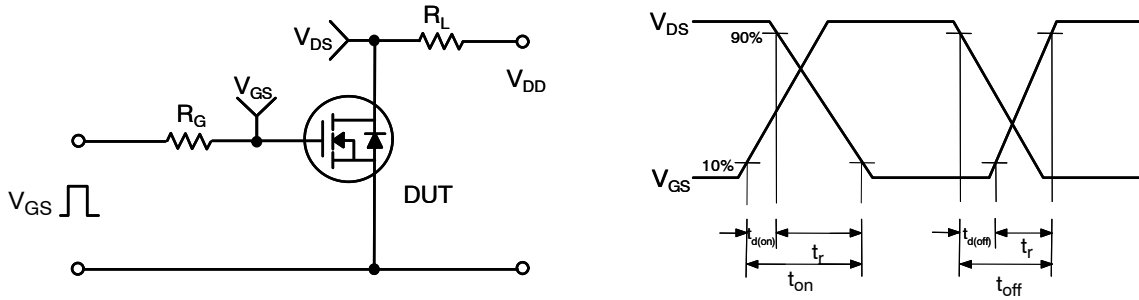


Figure 13. Resistive Switching Test Circuit & Waveforms

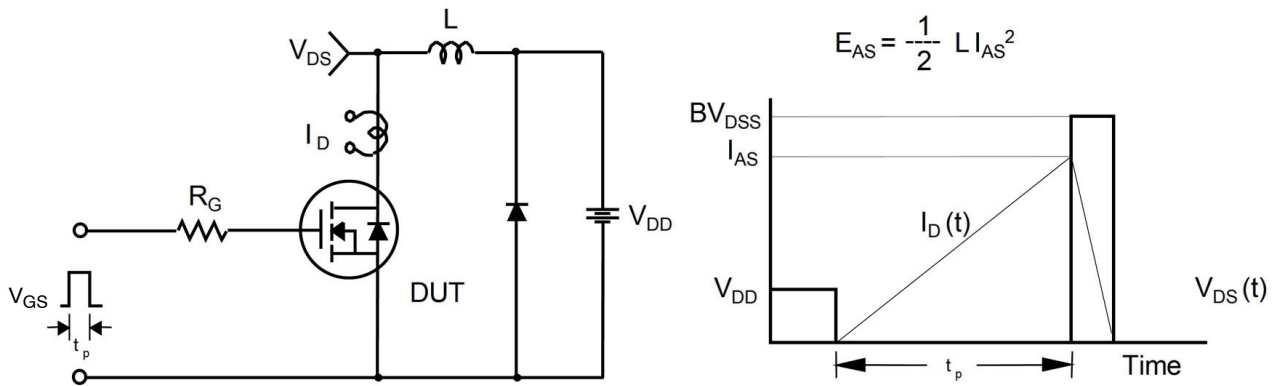
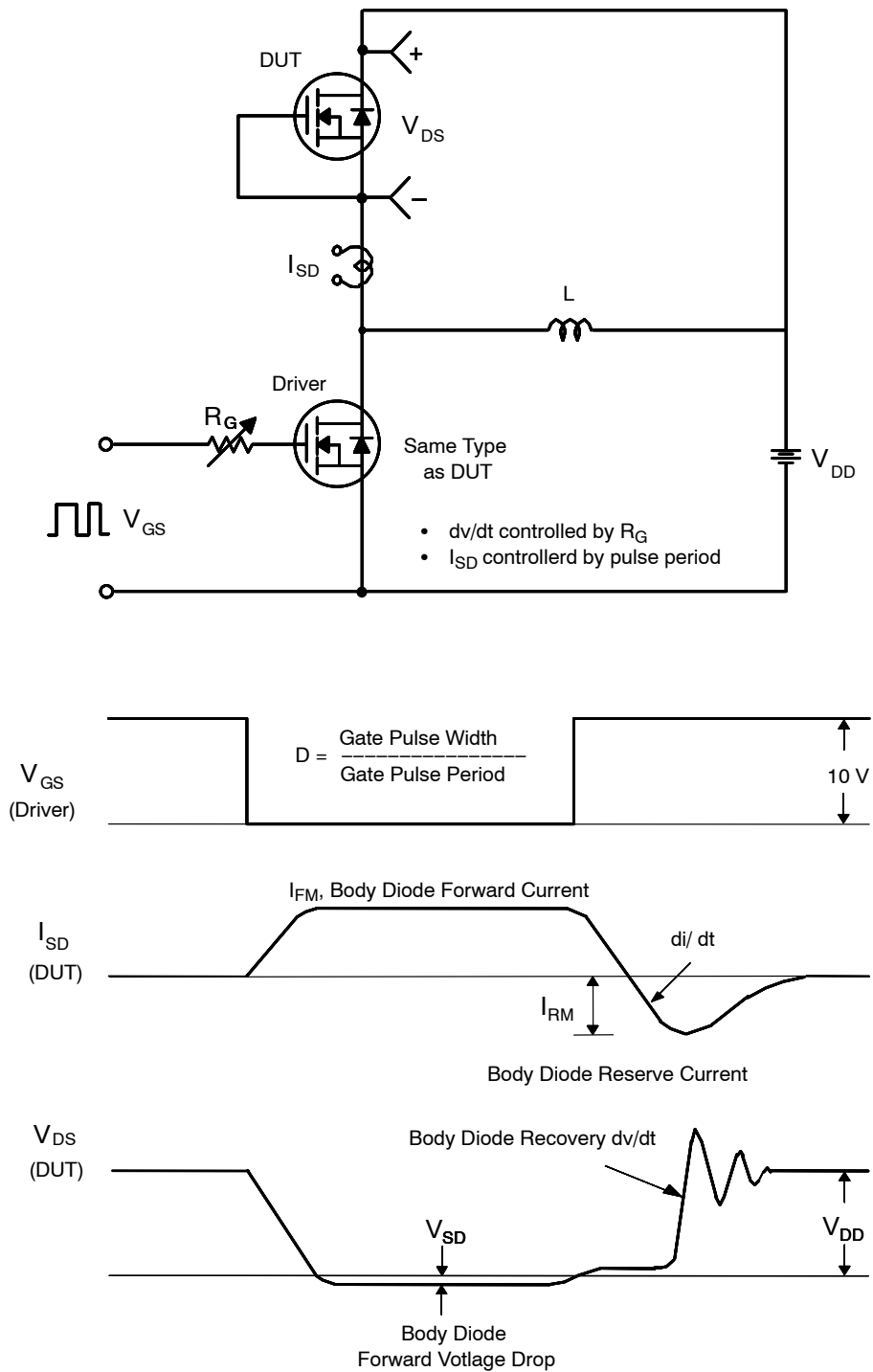


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

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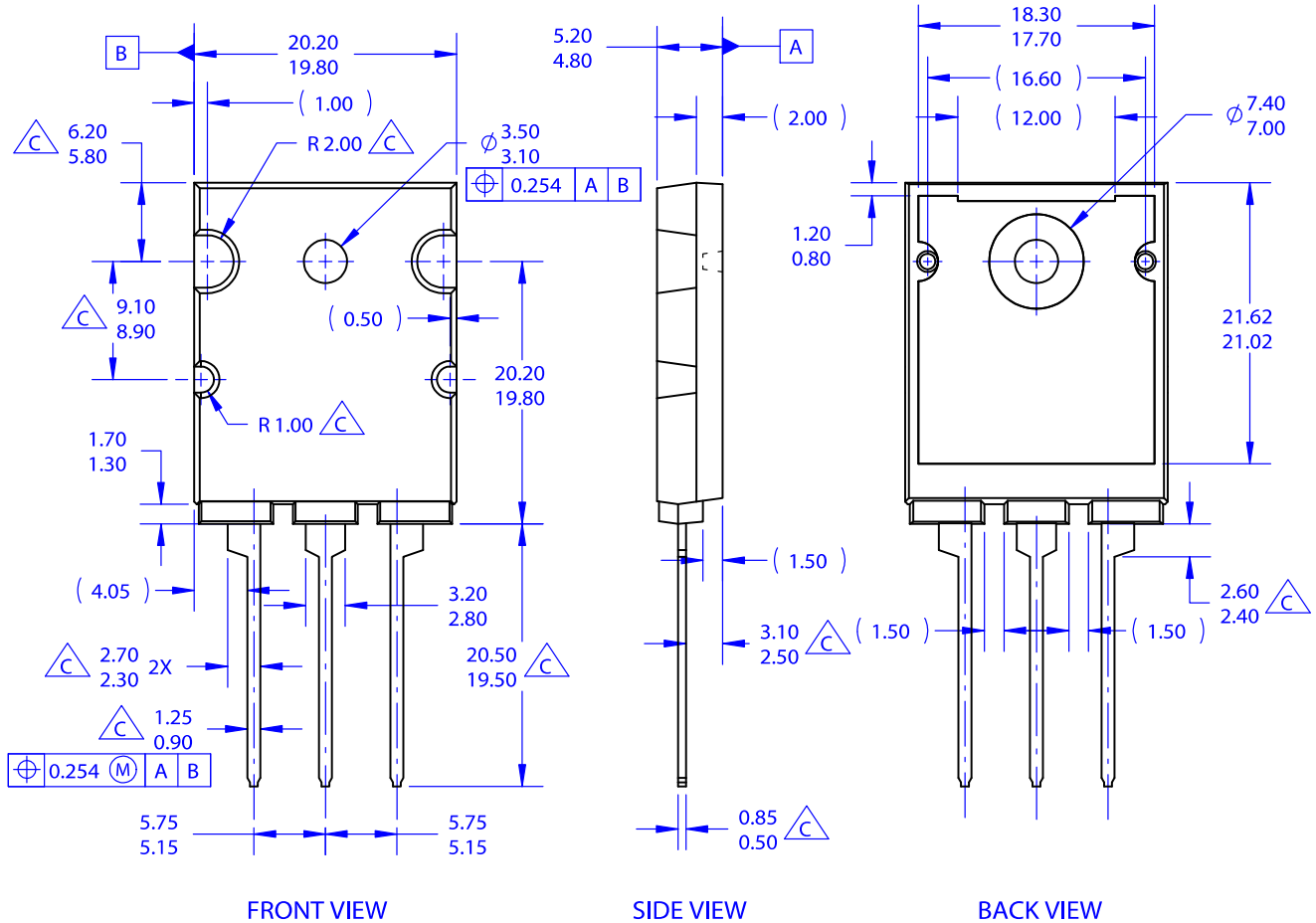
**Figure 15. Peak Diode Recovery  $dv/dt$  Test Circuit & Waveforms**

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CASE 340CA  
ISSUE O

DATE 31 OCT 2016



NOTES:

- A. PACKAGE REFERENCE: JEDEC TO264 VARIATION AA.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. OUT OF JEDEC STANDARD VALUE.
- D. DIMENSION AND TOLERANCE AS PER ASME Y14.5-1994.
- E. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.

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